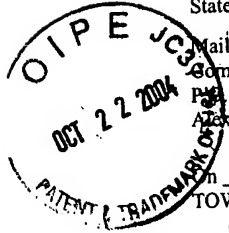


IFW

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PATENT
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Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

10/19/04
TOWNSEND and TOWNSEND and CREW LLP

By: [Signature]

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

ZHENJIANG CUI et al.

Application No.: 10/730,193

Filed: December 5, 2003

For: GAPFILL PROCESS USING A
COMBINATION OF SPIN-ON-
GLASS DEPOSITION AND
CHEMICAL VAPOR
DEPOSITION TECHNIQUES

Confirmation No. 8868

Examiner: Alexander G. Ghyka

Technology Center/Art Unit: 2812

RESPONSE

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed July 26, 2004, please enter the following amendments and remarks:

Remarks/Arguments begin on page 2 of this paper.